IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

81716.0117 Express Mail Label No. EV 324 111 812 US

(De application of:

Yoshihiro BASHO, Ryuji MORI and Masahiko MIYAUCHI

Serial No: Not assigned

January 15, 2004

Filed: For:

Heat Releasing Member, Package for Accommodating Semiconductor

Element and Semiconductor Device

Mail Stop PATENT APPLICATION Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Dear Sir:

CORRESPONDENCE ADDRESS:

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000026021

Transmitted herewith for filing is the patent application identified above.				
CALCULATION OF FEES	7			
ITEM TOTAL NO. OF NO. OF CLAIMS LG/SM \$ AMOUNT \$ FEE				
A TOTAL CLAIMS FEDE 17 -20 0 LG=\$18 SM=\$9 \$18 \$ 0				
B INDEPENDENT CLAIMS FEE* 4 -3 1 LG=\$86 SM=\$43 \$86 \$86				
C SUBTOTAL - ADDITIONAL CLAIMS FEE (ADD FINAL COLUMN IN LINES A + B) \$ 86	_			
D MULTIPLE-DEPENDENT CLAIMS FEE LARGE ENTITY FEE = \$290 SMALL ENTITY FEE = \$145 \$ 0				
E BASIC FEE . LARGE ENTITY FEE = \$770 SMALL ENTITY FEE = \$385 \$ 770				
F TOTAL FILING FEE (ADD TOTALS FOR LINES C, D, AND E)				
G ASSIGNMENT RECORDING FEE \$40 \$ 40	_			
*LIST INDEPENDENT CLAIMS 1, 2, 10 and 11.				
 □ Please charge my Deposit Account No. 50-1314 the amount of \$_0 A copy of this letter is enclosed. □ A check in the amount of \$_0_ to cover the filing fee is enclosed. □ A check in the amount of \$_40.00_ to cover Assignment Recordation fee is enclosed. □ The Commissioner is hereby authorized to charge any deficiency for the following fees associated with this communication or credit any overpayment to Deposit Account No. 50-1314. A copy of this sheet is enclosed. □ Any additional filing fees required under 37 C.F.R. 1.16 □ Any patent application processing fees under 37 C.F.R. 1.17 				
Respectfully submitted, HOGAN & HARTEGIN L L P				
Anthony J. Orlet				
500 South Grand Avenue, Suite 1900 Los Angeles, CA 90071 Telephone: (213) 337-6700 Registration No. 41,232 Attorney for Applicant(s)				

Facsimile:

(213) 337-6701

Attorney Docket No: 81716.0117

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In re application of:	Art Unit:	Not assigned
Yoshihiro BASHO et al.	Examiner:	Not assigned

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> CERTIFICATE OF MAILING VIA U.S. EXPRESS MAIL "Express Mail" Mailing Label No. EV 324 111 812 US Date of Deposit: January 15, 2004

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Dear Sir:

I hereby certify that

- two copies of a letter of transmittal
- patent application (<u>137</u> page(s) of specification; <u>17</u> claim(s); <u>1</u> page(s) of abstract
- 7 sheet(s) of formal drawings
- Certified copies of Japanese Patent Application Nos. 2003-007011 filed January 15, 2003, 2003-009843 filed January 17, 2003, 2003-015996 filed January 24, 2003, 2003-015997 filed January 24, 2003, 2003-021122 filed January 29, 2003, 2003-021123 filed January 29, 2003, 2003-035703 filed February 13, 2003, 2003-086191 filed March 26, 2003 and 2003-086195 filed March 26, 2003 from which priority is claimed under 35 U.S.C. § 119
- return postcard

are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service with sufficient postage under 37 C.F.R. § 1.10 on the date indicated above and are addressed to:

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P.O. Box 1450 Arlington, VA 22313-1450 Date: January 15, 2003

Hogan & Hartson, LLP 500 South Grand Avenue, Suite 1900 Los Angeles, California 90071 Telephone: 213-337-6700 Facsimile: 213-337-6701

Revnaldo Gallardo Name of person mailing papers Signature